

# Hermetic packaging of implantable devices: How did we get here? And where are we going?

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ADVANCED OUTSOURCING SOLUTIONS FOR ACTIVE IMPLANTS AND MINIMALLY INVASIVE DEVICES

#### What is hermeticity?

hermeticity (h3:məˈtɪsɪtɪ)

► Definitions

noun

the state of being airtight or gastight

Implantable devices really should be both...

- Water tight
- Ion tight



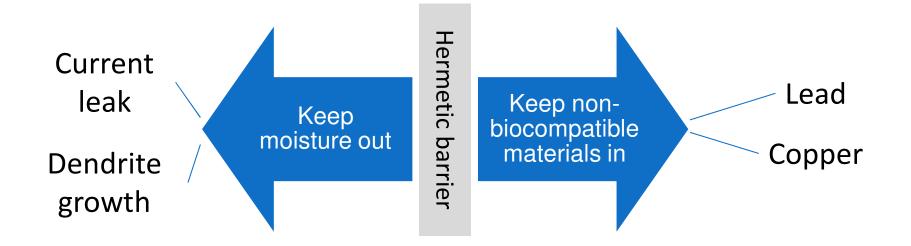
#### But nothing is really hermetic...

			IOW MUCH?
LEAK Leak rate (atm-cc/sec)	RATE CONVE Leak rat (cc/time)	e	TABLE Time required to form one bubble (1/8" dia) under water
10-1 atm-cc/sec	1 cc/ 10 se	ec	Steady stream
10-2 atm-cc/sec	1 cc/ 100 s	ec	1.5 seconds
10-3 atm-cc/sec	1 cc/ 17 m	un	15 seconds
10-4 atm-cc/sec	1 cc/ 3 hou	urs .	150 seconds
10-5 atm-cc/sec	1 cc / day		25 minutes
10-6 atm-cc/sec	1 cc/ 12 da		
10-7 atm-cc/sec	1 cc/ 17 we		Bubbles are
10-8 atm-cc/sec	1 cc/ 3 yea		too infrequent
10-9 atm-cc/sec	1 cc/ 32 ye		to be observed
10-10 atm-cc/sec	1 cc/ 318 ye		
PCICAL LEAK R Application	ATE SPECIFIC Leak rate (atm-cc/sec)	ATION	S BY APPLICATIO
Forque converter	10-3 to 10-4		Retention of liquid
verage can end	10-6 to 10-7	Retention of CO2	
Auto air bag	10-5 to 10-8		Guaranteed operation
acuum furnace	10-6 to 10-8		Leak tight
IC nackage	10-7 to 10-8	Pre	vent ingress of moisture
table medical device	10-9 to 10-10		vent ingress of moisture

Devices should be sufficiently hermetic to ensure function and safety.



#### Why does hermeticity matter?



Moisture can lead to...

- Power drain
- Non-function
- Unpredictable or unintended function



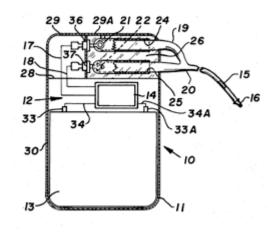
#### Hermeticity in history...



*Siemens pacemaker (First implanted 1958)* 



Chardack-Greatbatch (First implanted 1960)





Cardiac Pacemakers, Inc. (Patented 1974)

#### **Architecture evolution?**





#### **Determining acceptable leak rate**

- How much moisture is acceptable in the device?
  - MIL-STD vs EN 44502 vs 5000 ppm vs 3 monolayers of water...
- How much moisture will be sealed into the device?
  - Moisture in the components (Handling, environmental humidity, etc.)
  - Vacuum bake
  - Desiccants
- How long does the device need to survive?
  - How long is therapy required?
  - How long will the power source last?
  - How complicated is it to remove the device?
- How much tracer gas do you have?
  - Internal free volume
  - Helium concentration



#### **Determining acceptable leak rate**

Determination of Helium Tracer Gas Leak Rates to Support Hermeticity Requirements					
LEAK RATE SUMMARY (REFERENCE TD110492 FOR BACKGROU	IND & DETAILED METHOD	OLOGY)			
Approach #1: Leak rate based on European Standard EN 45502-2-3:2010					
Measured helium leak rate:	1.23E-08	atm-cc/sec			
Approach #2: Leak rate based on MIL-STD-883H, Method 10	14.13				
Measured helium leak rate:	6.82E-08	atm-cc/sec			
Approach #3: Typical leak rates reported by the Leak Detect	tion Equipment Manufact	turers			
Leak rate specification based on chart:	10 <sup>-9</sup> to 10 <sup>-10</sup>	atm-cc/sec			
Approach #4: Determining an acceptable leak rate based or acceptable internal relative humidity	n the device life and the r	naximum			
Measured helium leak rate:	9.91E-11	atm-cc/sec			
Approach #5: Determining an acceptable leak rate based of accumulation of 3 monolayers of water over the specified de	• •	ulting in the			
Measured helium leak rate:	1.62E-11	atm-cc/sec			

Risk should help drive specification development.



#### **Measurement methods**



#### In-process testing

- Gross leak
- Fine leak

## Most typically used, but limited for low leak rates



#### Developing test methods

- Cumulative helium
- Optical

Allows lower leak rates, but not production ready

# 517005

#### Monitoring

- Electrical characteristics
- Moisture sensors

Monitoring rather than screening could result in latent failure



#### **Measurement methods**

Most fine leak test methods use helium tracer gas...

- Inert
- Small molecule
- Easy to detect
- Low levels in background atmosphere



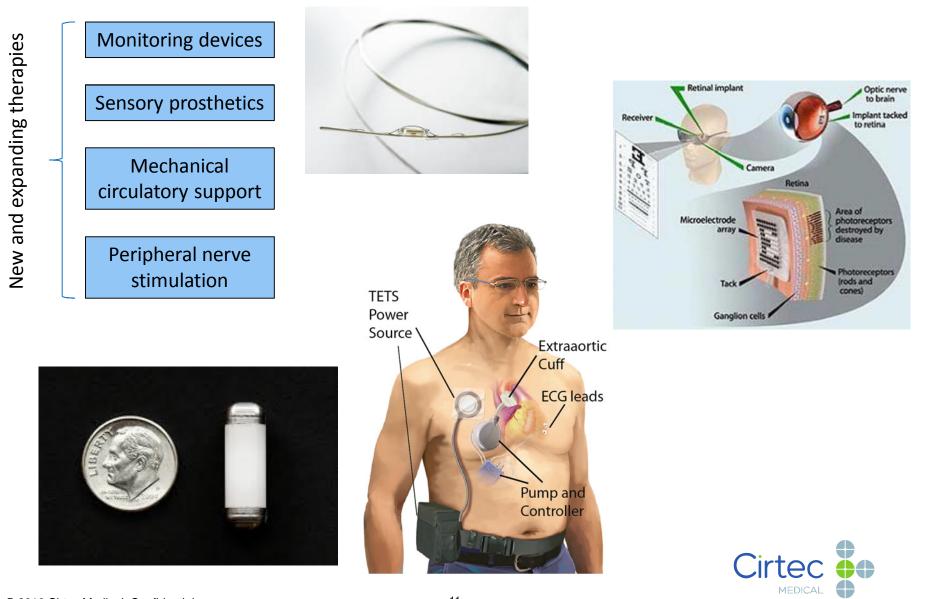
Helium bomb

Tracer gas sealed into device

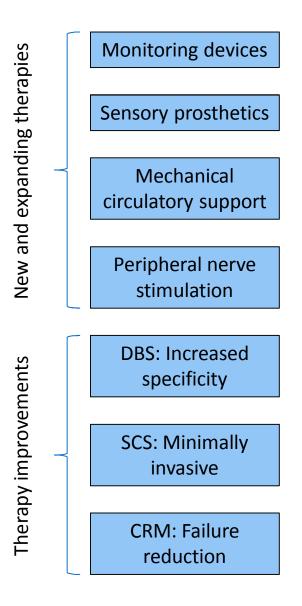


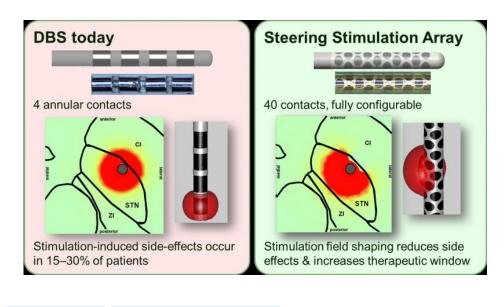


#### **Industry trends**



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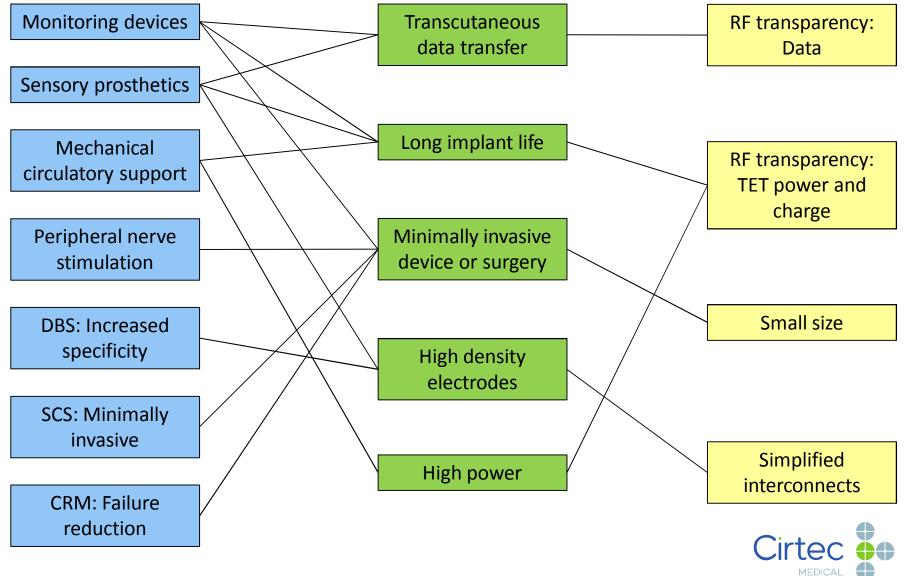


### freedom-8A

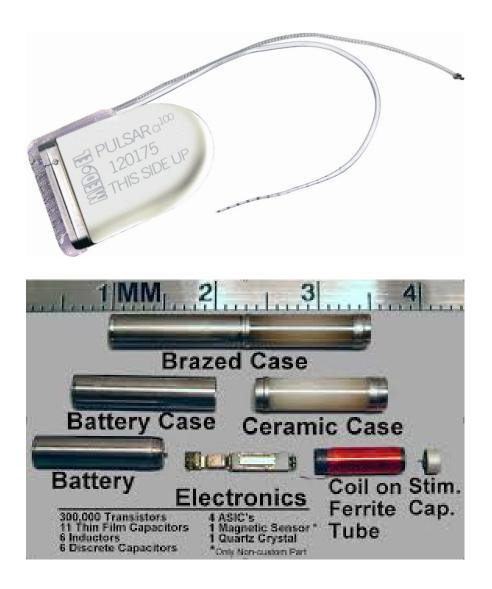


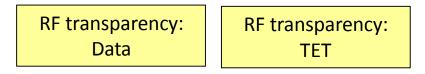


#### **Industry trends**



#### **Ceramic packaging**

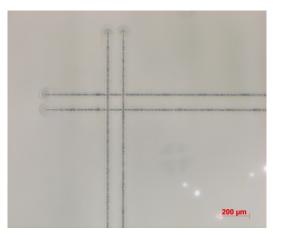




- Established implant use
- Good hermeticity
- Thicker walls than metals
- High temperature sealing
- Mechanical impact challenges



#### **Glass packaging**



Images courtesy of GlencaTec.



RF transparency: Data

RF transparency: TET

- Good hermeticity
- Proprietary materials or sealing processes
- Vias/feedthroughs require device-by-device development



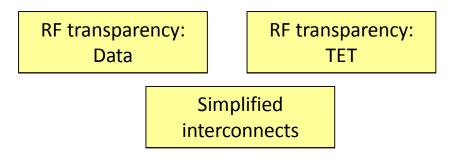


#### **Ambient Temperature Bonding**





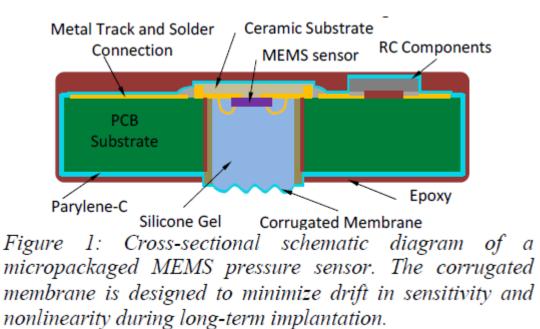
Images: Invenios



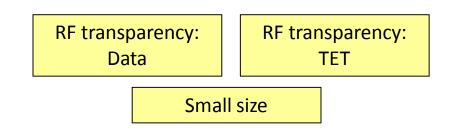
- Ambient temperature process
- Glass, silicon, ceramics, metals
- Small bond zone
- Incorporate electrical leads into bond



#### **Polymer encapsulation**



P. Wang et al., Transducers 2015, Anchorage, AK



Need for small size and RF transparency is driving some implant designers back to polymer encapsulants.



#### **Polymer encapsulation**

#### Desired properties of encapsulants

- Cured without voids
- Low modulus or designed to withstand thermal stress
- Hydrolytic stability (long term adhesion in water)
- Cures at moderate temperatures

#### Desired properties of encapsulated materials

- Corrosion resistant or passivated by oxide
- Good adherend for encapsulant

Adapted from material presented by Dr. Nick Donaldson of University College London at University of Washington on 10/26/2015.



#### **Chemical vapor deposition**

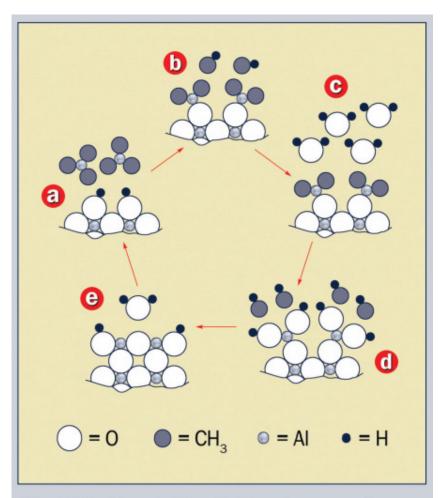
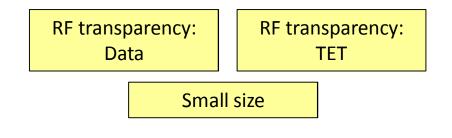


Figure 1-1: Five-step cycle (a through e) to produce one monolayer of Alumina ceramic ( $AI_2O_3$ ) on a surface. Image courtesy of Sundew Technologies LLC.

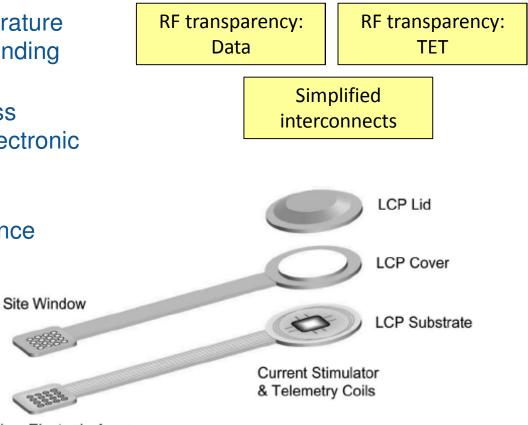


- Conformal coating of ceramic
- In theory, can be truly hermetic
- Cannot be tested by traditional hermetic test methods



#### Liquid crystal polymer

- High temperature and low temperature LCP laminated to allow fusion bonding
- Requires moderately high process temperatures, which may limit electronic component selection
- Promising fluid ingress performance



Micro Electrode Array

"Monolithic Encapsulation of Implantable Neuroprosthetic Devices Using Liquid Crystal Polymers", Kim S-J, et al., IEEE Trans BME, 58(8) 2255-2263, 2011.

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